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Kind regards,

Team Nexperia



40 V, 600 mA, PNP switching transistor 5 March 2015

Product data sheet

1. General description

PNP switching transistor in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

NPN complement: PMBT4401

2. Features and benefits

- Single general-purpose switching transistor
- AEC-Q101 qualified

3. Applications

• Switching and linear amplification

4. Quick reference data

Table 1. Q	uick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	-40	V
I _C	collector current		-	-	-600	mA
h _{FE}	DC current gain	V_{CE} = -2 V; I_C = -150 mA; T_{amb} = 25 °C	100	-	300	

5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	В	base	3	C
2	E	emitter		в
3	С	collector	1 2 TO-236AB (SOT23)	E sym132





40 V, 600 mA, PNP switching transistor

6. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
PMBT4403	TO-236AB	plastic surface-mounted package; 3 leads	SOT23				

7. Marking

Table 4. Marking codes	
Type number	Marking code
	[1]
PMBT4403	%2T

[1] % = placeholder for manufacturing site code

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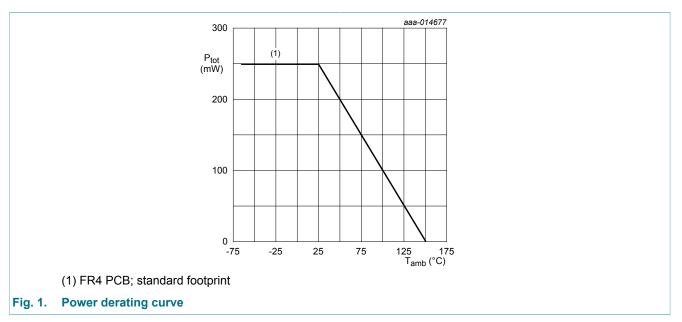
Limiting values 8.

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V _{CBO}	collector-base voltage	open emitter		-	-40	V
V _{CEO}	collector-emitter voltage	open base		-	-40	V
V _{EBO}	emitter-base voltage	open collector		-	-5	V
I _C	collector current			-	-600	mA
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	-800	mA
I _{BM}	peak base current			-	-200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	250	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-65	150	°C
T _{stg}	storage temperature			-65	150	°C

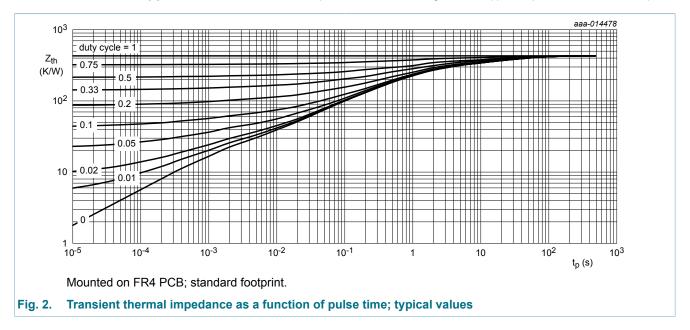
[1] Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.



Thermal characteristics 9.

Table 6.	Thermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	500	K/W
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40 V, 600 mA, PNP switching transistor



[1] Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

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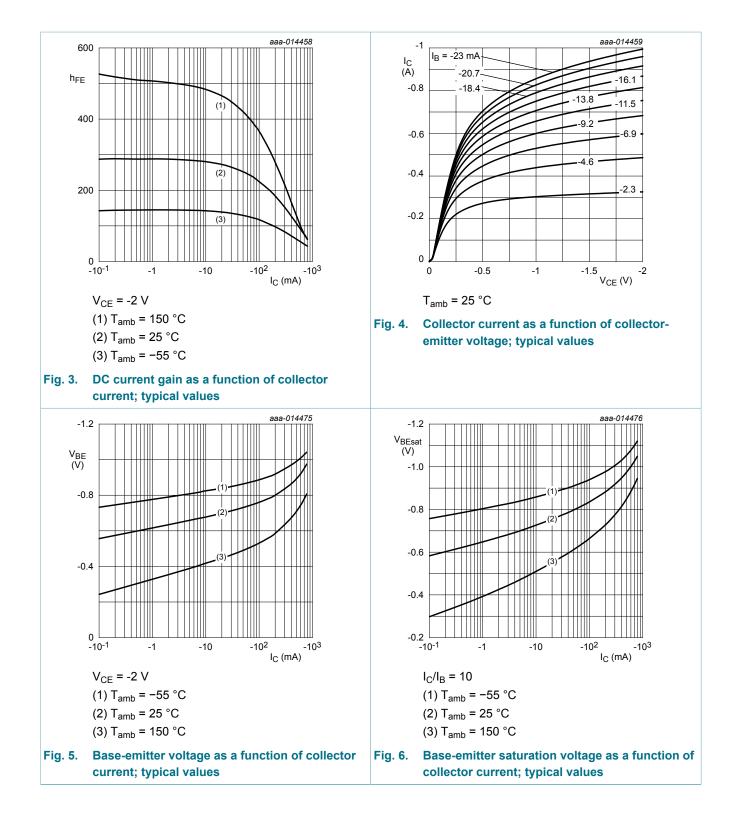
10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
I _{CBO}	collector-base cut-off current	V_{CB} = -40 V; I _E = 0 A; T _{amb} = 25 °C	-	-	-50	nA
I _{EBO}	emitter-base cut-off current	V_{EB} = -5 V; I _C = 0 A; T _{amb} = 25 °C	-	-	-50	nA
h _{FE}	DC current gain	V_{CE} = -1 V; I _C = -0.1 mA; T _{amb} = 25 °C	30	-	-	
		V_{CE} = -1 V; I _C = -1 mA; T _{amb} = 25 °C	60	-	-	
		V_{CE} = -1 V; I _C = -10 mA; T _{amb} = 25 °C	100	-	-	
		V_{CE} = -2 V; I _C = -150 mA; T _{amb} = 25 °C	100	-	300	
		V_{CE} = -2 V; I _C = -500 mA; T _{amb} = 25 °C	20	-	-	
V _{CEsat}	collector-emitter saturation voltage	I _C = -150 mA; I _B = -15 mA; T _{amb} = 25 °C	-	-	-400	mV
		I _C = -500 mA; I _B = -50 mA; T _{amb} = 25 °C	-	-	-750	mV
V _{BEsat}	base-emitter saturation voltage	I _C = -150 mA; I _B = -15 mA; T _{amb} = 25 °C	-	-	-950	mV
		I _C = -500 mA; I _B = -50 mA; T _{amb} = 25 °C	-	-	-1.3	V
t _d	delay time	I _C = -150 mA; I _{Bon} = -15 mA;	-	-	15	ns
t _r	rise time	I _{Boff} = 15 mA; T _{amb} = 25 °C	-	-	30	ns
t _{on}	turn-on time	-	-	-	40	ns
t _s	storage time	-	-	-	300	ns
t _f	fall time	-	-	-	50	ns
t _{off}	turn-off time	-	-	-	350	ns
C _C	collector capacitance	V _{CB} = -10 V; I _E = 0 A; i _e = 0 A; f = 1 MHz; T _{amb} = 25 °C	-	-	8.5	pF
C _E	emitter capacitance	V _{EB} = -500 mV; I _C = 0 A; i _c = 0 A; f = 1 MHz; T _{amb} = 25 °C	-	-	35	pF
f _T	transition frequency	V_{CE} = -10 V; I _C = -20 mA; f = 100 MHz; T _{amb} = 25 °C	200	-	-	MHz

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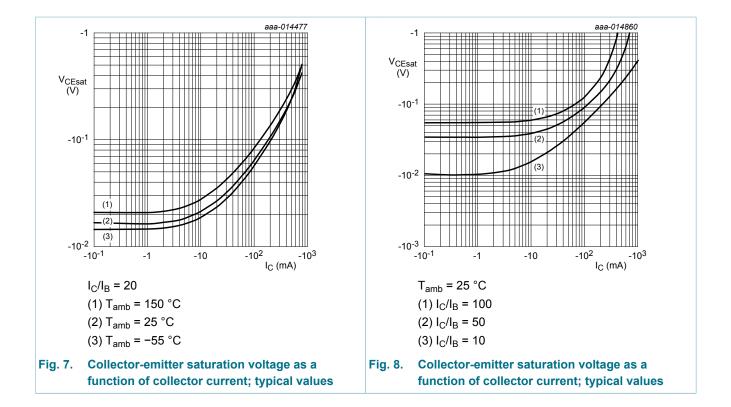


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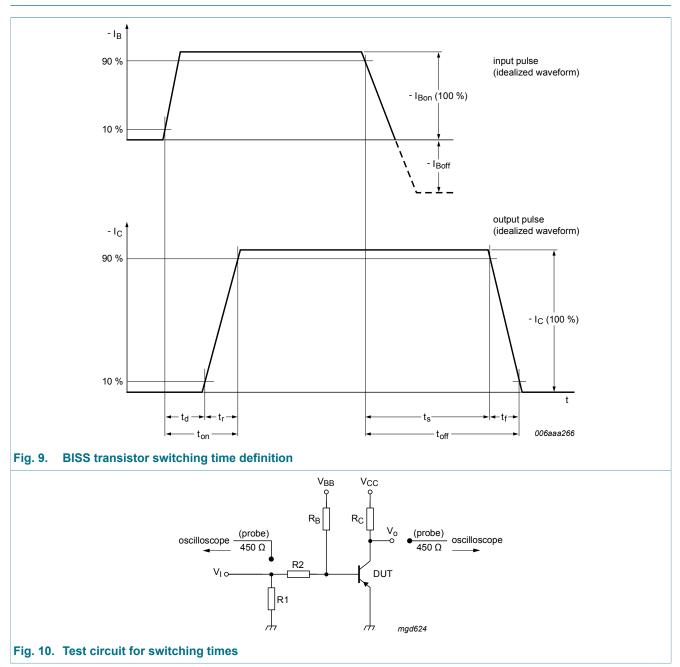
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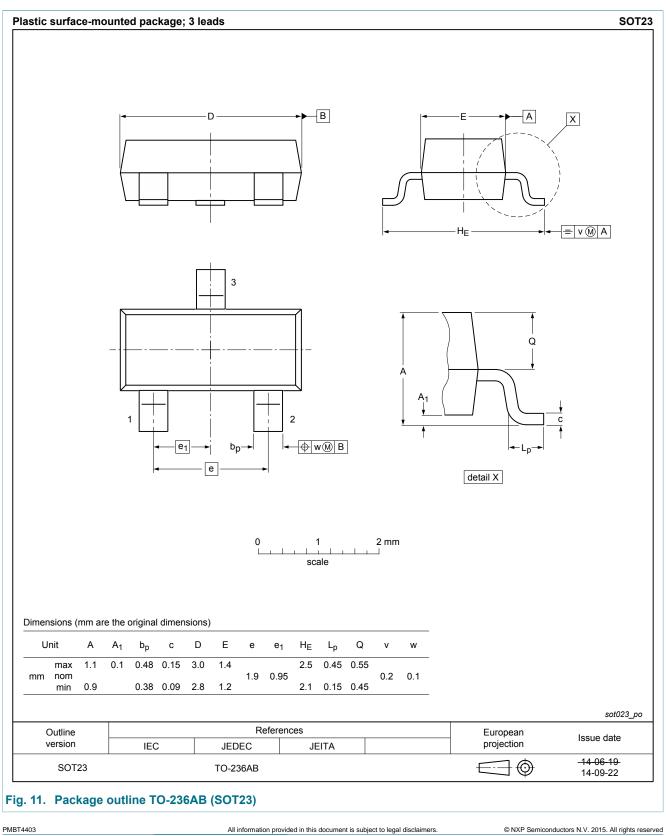
11. Test information

11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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12. Package outline

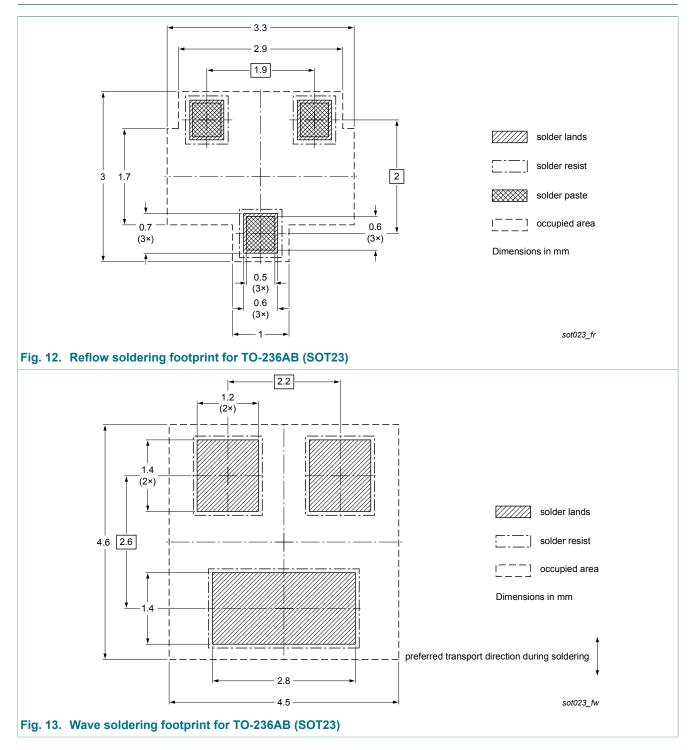


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13. Soldering



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14. Revision history

Table 8. Revision history								
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
PMBT4403 v.5	20150305	Product data sheet	-	PMBT4403 v.4				
Modifications:	of NXP Semiconduc	ctors	signed to comply with the ompany name where app					
PMBT4403 v.4	20040121	Product data sheet	-	PMBT4403 v.3				
PMBT4403 v.3	19990415	Product specification	-	PMBT4403 v.2				
PMBT4403 v.2	19970505	Product specification	-	PMBT4403 v.1				
PMBT4403 v.1	19940901	Product specification	-	-				

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15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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